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BIBDATASHEET

Bib Data Sheet

CONFIRMATION NO. 8851

SERIAL NUMB 09/699,466		FILING DATE 10/31/2000 RULE		LASS 438	GRO	UP ART (2829	UNIT	D(TTORNEY OCKET NO. 0756-2222				
APPLICANTS													
Shunpei Yamaza	ıki, To	kyo, JAPAN;											
	nagav awa, I	wa, JAPAN;Yasushi Oga Kanagawa, JAPAN;	ata, Kanaç	gawa, JAPAN	;								
** CONTINUING DATA **********************************													
** FOREIGN APPLICATIONS ************************************													
IF REQUIRED, F ** 01/03/2001	OREI	GN FILING LICENSE G	RANTED)									
Foreign Priority claime 35 USC 119 (a-d) con met	ditions	□ yes □ no □ Met after	Allowance	STATE OR	SH	IEETS	то	TAL	INDEPENDENT				
Verified and As Su United Scanner's Signature Initials				COUNTRY JAPAN	DR.	DRAWING 7		NMS 25	CLAIMS 6				
ADDRESS 31780 ERIC ROBINSON PMB 955 21010 SOUTHBA POTOMAC FALL 20165	ANK S												
TITLE METHOD FOR F	ABRI	CATING A SEMICOND	UCTOR [DEVICE									
								☐ All Fees					
	FEES	FEES: Authority has been given in Paper No. to charge/credit DEPOSIT ACCOUNT					☐ 1.16 Fees (Filing) ☐ 1.17 Fees (Processing Ext. of time)						

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BID Data Sheet					
SERIAL NUMBER 09/699,466	FILING DATE 10/31/2000 RULE	CLASS 438	GROUP ART U 2829		ATTORNEY DOCKET NO. 0756-2222
Satoshi Teramo Jun Koyama, Ka Yasushi Ogata, Masahiko Hayal Mitsuaki Osame ** CONTINUING DAT THIS APPLICA ** FOREIGN APPLICA JAPAN 8-32874		AN; ** YES AICS ***** YES AICS **** YES AICS	T 6,180,439		
** 01/03/2001 Foreign Priority claimed 35 USC 119 (a-d) conditions met Verified and	yes no Met aff	STATE OR COUNTRY	SHEETS DRAWING 7	TOTAL CLAIMS 25	INDEPENDENT CLAIMS 6
ADDRESS 31780	animoro organización	W			
TITLE Method for fabricating	a semiconductor devic	ce			
FILING FEE FEE RECEIVED No. 1454 No.					